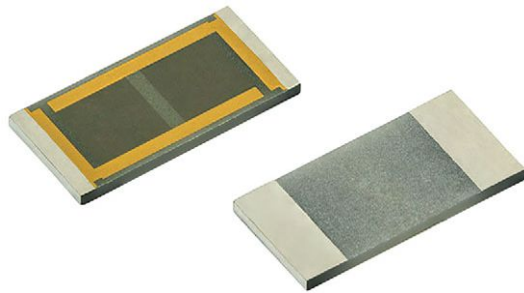


# High Power Aluminum Nitride, Wraparound Surface Mount, Precision Thin Film Non-Magnetic Chip Resistor (up to 6 W)



PCNM series chip resistors are designed on aluminum nitride ceramic substrates with enlarged backside terminations to reduce the thermal resistance between the topside resistor layer and the solder joint on the end users circuit assembly.

Actual power handling capability is limited by the end user mounting process. As with any high power chip resistor the ability to remove the heat is critical to the overall performance of the device.

## FEATURES

- High thermal conductivity aluminum nitride substrate
- Power rating up to 6.0 W
- Resistance range 2 Ω to 30.1 kΩ
- Resistor tolerance to ± 0.1 %
- TCR to ± 25 ppm/°C
- Flame resistant UL 94 V-0

## APPLICATIONS

- Power supplies
- Power switching
- Braking system

## TYPICAL PERFORMANCE

	ABSOLUTE
TCR	25
TOL.	0.1

STANDARD ELECTRICAL SPECIFICATIONS		
TEST	SPECIFICATIONS	CONDITIONS
Material	Nichrome	-
Resistance Range	2 Ω to 30.1 kΩ	-
TCR: Absolute	25 ppm/°C (standard) and 100 ppm/°C	-
Tolerance: Absolute	0.1 %, 0.25 %, 0.5 %, 1.0 % and 5.0 %	-55 °C to +150 °C
Power Rating: Resistor	0.5 W to 6.0 W <sup>(1)</sup>	Maximum at +70 °C
Stability: Absolute	ΔR 1.0 %	1000 h at +70 °C
Voltage Coefficient	< 0.1 ppm/V	-
Working Voltage	75 V to 200 V	-
Operating Temperature Range	-55 °C to +155 °C	-
Storage Temperature Range	-55 °C to +155 °C	-
Noise	< -30 dB	-
Shelf Life Stability: Absolute	± 0.01 %	1 year at +25 °C

### Note

<sup>(1)</sup> Dependant on component mounting by user.

COMPONENT RATINGS			
CASE SIZE	POWER RATING (mW)	WORKING VOLTAGE (V)	RESISTANCE RANGE (Ω)
1206	2000 <sup>(2)</sup>	200	2 to 30.1K
2512	6000 <sup>(2)</sup>	200	2 to 30.1K

### Notes

• 0603 and 0805 case size under engineering qualification.

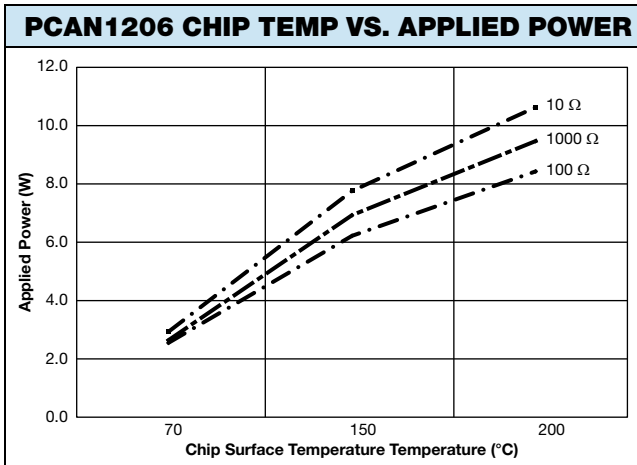
<sup>(2)</sup> Dependant on component mounting by user.

<b>ENVIRONMENTAL TESTS</b>		
<b>ENVIRONMENTAL TEST</b>	<b>LIMITS MIL-PRF-55342 CHARACTERISTIC "H"</b>	<b>TYPICAL VISHAY PERFORMANCE</b>
Resistance temperature characteristic	± 50 ppm/°C	± 25 ppm/°C
Maximum ambient temperature at rated wattage	+70 °C	+70 °C
Maximum ambient temperature at power derating	+150 °C	+150 °C
Thermal shock	± 0.25 %	± 0.10 %
Low temperature operation	± 0.25 %	± 0.10 %
Short time overload	± 0.1 %	± 0.10 %
High temperature exposure	± 0.2 %	± 0.10 %
Resistance to soldering heat	± 0.25 %	± 0.10 %
Moisture resistance	± 0.4 %	± 0.50 %
Life at +70 °C for 1000 h	± 0.5 %	± 1.00 %

<b>DIMENSIONS</b> in inches					
<b>CASE SIZE</b>	<b>LENGTH L</b>	<b>WIDTH W</b>	<b>THICKNESS T MIN./MAX.</b>	<b>TOP PAD D</b>	<b>BOTTOM PAD E</b>
1206	0.126 ± 0.008	0.063 ± 0.005	0.015 ± 0.003	0.020 + 0.005 / - 0.010	0.040 ± 0.005
2512	0.259 + 0.009 / - 0.015	0.124 ± 0.005	0.015 ± 0.003	0.020 ± 0.005	0.050 ± 0.005

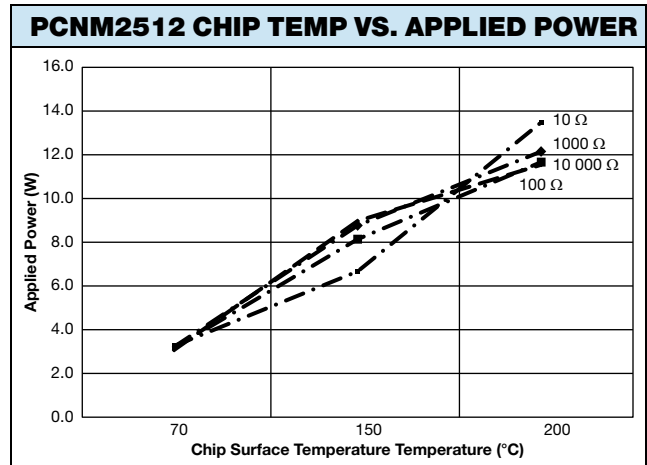
<b>LAND PATTERN DIMENSIONS</b> in inches	
<p><b>0805 Land Pattern</b></p>	<p><b>2512 Land Pattern</b></p>

<b>STANDARD MATERIAL SPECIFICATIONS</b>	
Resistive element	Nichrome
Substrate material	Aluminum nitride
Terminations (tin / lead)	Tin / lead solder over nickel barrier
Terminations (lead (Pb)-free)	Tin / silver / copper (Sn96.5 / Ag3.0 / Cu0.5) solder over nickel barrier



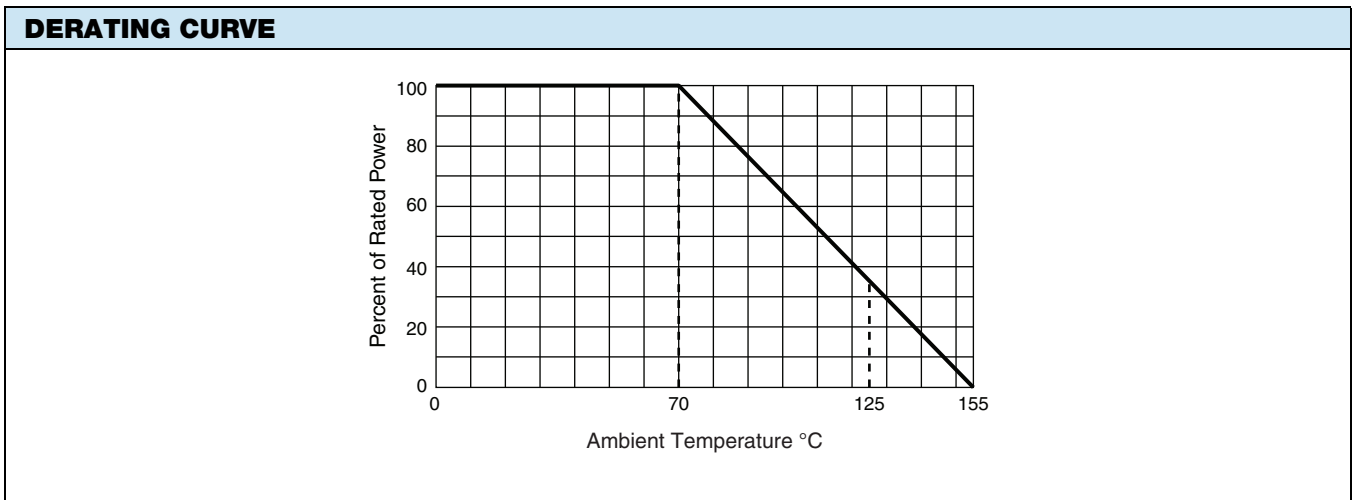
**Note**

- Chip surface temperature measured using FLIR SC645 thermal imaging system with an approximate test card surface temperature of 75 °C.



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GLOBAL PART NUMBER INFORMATION																
New Global Part Numbering: PCNM1206H1000BBT1																
<b>P</b>	<b>C</b>	<b>N</b>	<b>M</b>	<b>1</b>	<b>2</b>	<b>0</b>	<b>6</b>	<b>H</b>	<b>1</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>B</b>	<b>B</b>	<b>T</b>	<b>1</b>
GLOBAL MODEL <b>PCNM</b>	CASE SIZE <b>1206</b> <b>2512</b>	TCR CHARACTERISTIC <b>E</b> = ± 25 ppm/°C <b>H</b> = ± 50 ppm/°C <b>K</b> = ± 100 ppm/°C <sup>(1)</sup>		RESISTANCE The first 3 digits are significant figures and the last digit specifies the number of zeros to follow. "R" designates the decimal point.  Example: <b>10R0</b> = 10 Ω <b>1000</b> = 100 Ω		TOLERANCE <b>B</b> = ± 0.1 % <sup>(2)</sup> <b>C</b> = ± 0.25 % <b>D</b> = ± 0.5 % <b>F</b> = ± 1.0 % <sup>(1)</sup> <b>G</b> = ± 2.0 %		TERMINATION <b>B</b> = Wraparound Sn/Pb solder w/ nickel barrier <b>S</b> = Wraparound lead (Pb)-free solder (e1) RoHS compliant <b>G</b> = Wraparound Au, over Ni (gold) termination epoxy bondable RoHS compliant (e4)		PACKAGING <b>BS</b> = BULK 100 min., 1 mult <b>WS</b> = WAFFLE 100 min., 1 mult <b>W0</b> = 100 pc min. waffle, 1 mult <b>W1</b> = 100 min., 1 mult (package unit single lot date code)  TAPE AND REEL <b>T0</b> = 100 min., 100 mult <b>T1</b> = 1000 min., 1000 mult <b>T3</b> = 300 min., 300 mult <b>T5</b> = 500 min., 500 mult <b>TF</b> = Full reel <b>TS</b> = 100 min., 1 mult <b>TI</b> = 100 min., 1 mult (item single lot date code) <b>TP</b> = 100 min., 1 mult (package unit single lot date code)						

**Notes**

- (1) Less than 10 Ω 100 ppm/°C and 1 % tolerance best.
- (2) Available on 10 Ω and higher.



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